

Winstar Display Co., LTD 華凌光電股份有限公司



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SPECIFICATION

CUSTOMER:					
MODULE NO.:	WG320240B0-FFHVZ#000				
APPROVED BY:		DATA:			

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
ISSUED DATE:			



MODLE NO:

REC	ORDS OF REV	DOC. FIRST ISSUE	
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2007/10/12		First issue

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1. Module Classification Information

WG<u>320</u>240 B0-FFHVZ#000 ① ② 3 \$ 6 7

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type

3 Display Font: 320 * 240 Dots

Model serials number

⑤ Backlight Type: N→Without backlight T→LED, White

> B→EL, Blue green A→LED, Amber

D→EL, Green $R \rightarrow LED$, Red

W→EL, White O→LED, Orange

F→CCFL, White G→LED, Green

Y→LED, Yellow Green

 LCD Mode: B→TN Positive, Gray T→FSTN Negative

N→TN Negative,

G→STN Positive, Gray

Y→STN Positive, Yellow Green

M→STN Negative, Blue

F→FSTN Positive

② LCD Polarizer Type/ A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Temperature range/ D→Reflective, N.T, 12:00

View direction

K→Transflective, W.T, 12:00

G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive,

W.T,12:00

V: Built in negative Voltage Controller: RA8835 Special Code

Z:86Version

#:Fit in with the ROHS Directions and regulations 00:Sales code 0:Version(TS320240BRNO#)

2. Precautions in Use of LCD Module

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD Module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.

3. General Specification

ITEM	STANDARD VALUE	UNIT			
Number of dots	320x240	dots			
Outline dimension	166.8(W)x 109.0(H)x 15.0max(T)	mm			
View area	122.0(W)x 92.0(H)	mm			
Active area	115.18(W)x 86.38(H)	mm			
Dot size	0.34(W)x 0.34(H)	mm			
Dot pitch	0.36(W)x 0.36(H)	mm			
LCD type	FSTN Positive Transflective,				
View direction	6 o'clock				
Backlight	CCFL, White				

4. Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\! \mathbb{C}$
Input Voltage	V _I	0	_	V_{DD}	V
Supply Voltage For Logic	V_{DD}	0	_	6.5	V
Supply Voltage For LCD	V_{DD} - V_{EE}	0	_	32	V

5. Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Logic Voltage	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
		Ta=-20°C		_	26.2	V
Supply Voltage For	V_{DD} - V_{O}	Ta=25°C	_	24.0	_	V
LCD		Ta=+70°C	22.1	_	_	V
Input High Volt.	V _{IH}	_	$0.5V_{DD}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	V_{SS}	_	$0.2V_{DD}$	V
Output High Volt.	V_{OH}	_	2.4	_	_	V
Output Low Volt.	V_{OL}	_	_	_	0.4	V
Supply Current	I_{DD}	_	95.0	100.0	110.0	mA

6. Optical Characteristics

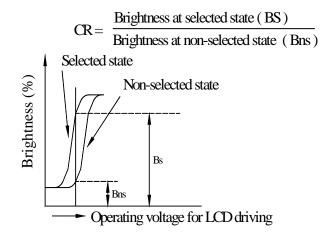
ITEM	SYMBAL	CONDITION	MIN	TYP	MAX	UNIT
	(V) θ	CR≧2	30		60	deg.
View Angle	(H) φ	CR≧2	-45	_	45	deg.
Contrast Ratio	CR	_	_	5	_	_
	T rise	_	_	200	300	ms
Response Time	T fall	_	_	150	200	ms

6.1 **Definitions**

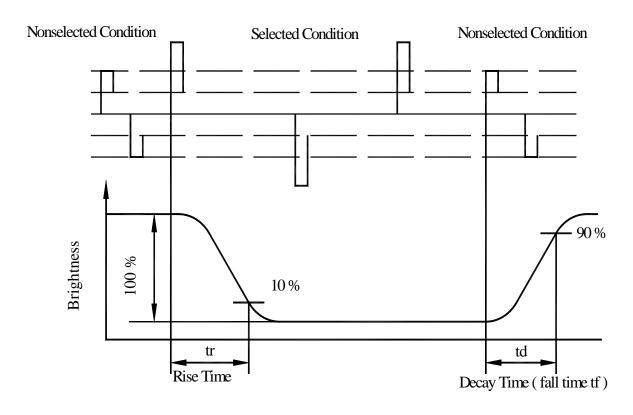
■View Angles

Z (Visual angle direction) $X_{\mathfrak{S}}$

Contrast Ratio



Response time

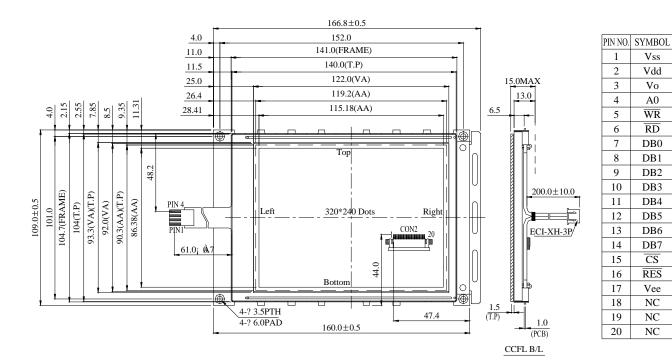


7. Interface Description

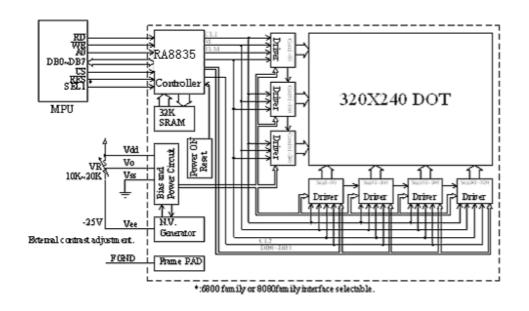
Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	V_{DD}	5.0V	Power supply for Logic
3	V_{O}	(Variable)	Driving voltage for LCD
4	A0	H/L	RD=L WR=H ,A0=L :Data Read AO=H :Status read RD=H WR=L ,A0=L :Data Write AO=H :Command write
5	WR	H/L	8080 family MPU interface: Write signal
6	RD	H/L	8080 family MPU interface: Read signal
7~14	DB0~DB7	H/L	Data bus line
15	CS	H/L	Chip select ,Active L
16	RES	H/L	Controller reset signal, Active L
17	V_{EE}	-	Negative voltage output
18	NC		No connection
19	NC		No connection
20	NC		No connection

Note1: Setup by hardware

8. Contour Drawing & Block diagram







9. INSTRUCTION SET

The Command Set

Class	Command		Code Hex Command Description					Command Description						
		RD	WR	Α0	D7	D6	D5	D4	D3	D2	D1	D0		
System	SYSTEM SET	1	0	1	0	1	0	0	0	0	0	0	40	Initialize device and display
CONTIG	SLEEP IN	1	0	1	0	1	0	1	0	0	1	1	53	Enter standby mode
	DISP ON/OFF	1	0	1	0	1	0	1	1	0	0	D	58, 59	Enable and disable dis- play and display flashing
	SCROLL	1	0	1	0	1	0	0	0	1	0	0	44	Set display start address and display regions
	CSRFORM	1	0	1	0	1	0	1	1	1	0	1	5D	Set cursor type
Display	CGRAM ADR	1	0	1	0	1	0	1	1	1	0	0	5C	Set start address of char- acter generator RAM
control	CSRDIR	1	0	1	0	1	0	0	1	1	CD 1	CD 0	4C to 4F	Set direction of cursor movement
	HDOT SCR	1	0	1	0	1	0	1	1	0	1	0	5A	Set horizontal scroll position
	OVLAY	1	0	1	0	1	0	1	1	0	1	1	5B	Set display overlay format
Drawing	CSRW	1	0	1	0	1	0	0	0	1	1	0	46	Set cursor address
control	CSRR	1	0	1	0	1	0	0	0	1	1	1	47	Read cursor address
Momore	MWRITE	1	0	1	0	1	0	0	0	0	1	0	42	Write to display memory
Memory control	MREAD	1	0	1	0	1	0	0	0	0	1	1	43	Read from display memory

Notes:

2-byte parameters (where two bytes are treated as 1 data item) are handled as follows:

- a. CSRW, CSRR: Each byte is processed individually. The microprocessor may read or write just the low byte of the cursor address.
- b. SYSTEM SET, SCROLL, CGRAM ADR: Both parameter bytes are processed together. If the command is changed after half of the parameter has been input, the single byte is ignored.
- 2. APL and APH are 2-byte parameters, but are treated as two 1-byte parameters.

^{1.} In general, the internal registers of the series are modified as each command parameter is input. However, the microprocessor does not have to set all the parameters of a command and may send a new command before all parameters have been input. The internal registers for the parameters that have been input will have been changed but the remaining parameter registers are unchanged.

System-Control Command

Initializes the device, sets the window sizes, and selects the LCD interface format. Since this command sets the basic operating parameters of the RA8835 series, an incorrect SYSTEM SET command may cause other commands to operate incorrectly.

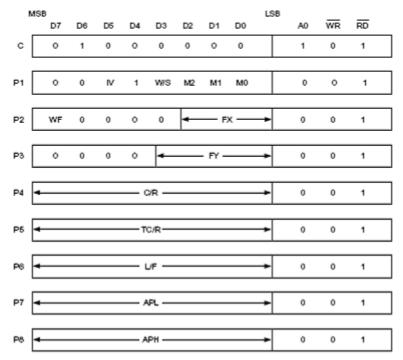


Figure 1. SYSTEM SET instruction

8.2.1.1. C

This control byte performs the following:

- 1. Resets the internal timing generator
- 2. Disables the display
- 3. Cancels sleep mode

Parameters following P1 are not needed if only canceling sleep mode.

8.2.1.2. M0

Selects the internal or external character generator ROM. The internal character generator ROM contains 160, 5 × 7 pixel characters, as shown in figure 70. These characters are fixed at fabrication by the metallization mask. The external character generator ROM, on the other hand, can contain up to 256 user-defined characters.

M0 = 0: Internal CG ROM M0 = 1: External CG ROM Note that if the CG ROM address space overlaps the display memory address space, that portion of the display memory cannot be written to.

8.2.1.3. M1

Selects the memory configuration for user-definable characters. The CG RAM codes select one of the 64 codes shown in figure 46.

M1 - 0: No D6 correction.

The CG RAM1 and CG RAM2 address spaces are not contiguous, the CG RAM1 address space is treated as character generator RAM, and the CG RAM2 address space is treated as character generator ROM.

M1 - 1: D6 correction.

The CG RAM1 and CG RAM2 address spaces are contiguout and are both treated as character generator RAM.

10.RELIABILITY

Content of Reliability Test (wide temperature, -20°c~70°C)

Environmental Test							
Test Item	Content of Test	Test Condition	Note				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2				
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs					
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°ℂ 200hrs	1				
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C John James John 1 cycle	-20°C/70°C 10 cycles					
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= 800 V,RS= 1.5 k Ω CS= 100 pF 1 time					

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Note3: Temperature and humidity after remove from theelf without putting it in a container.

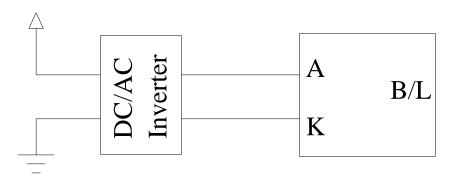
11. Backlight Information

CCFL backlight Specification

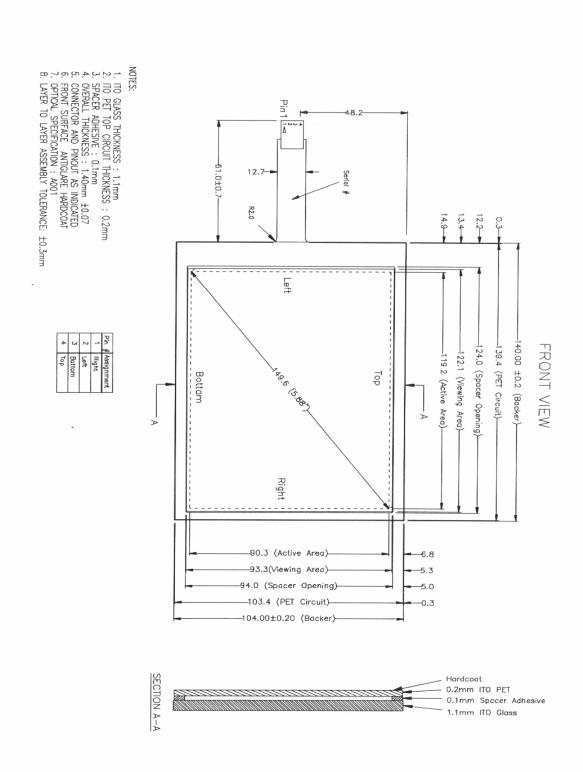
(Ta=25°℃)

					`	· · · · · · · · · · · · · · · · · · ·
Item	Symbol	Sp Min	ecificati Typ	on Max	Unit	Condition
Driving Voltage	$ m V_{FL}$	222.4	278	417	Vrms	_
Input current	I_{FL}	4.8	5.0	5.2	mArms	_
Power consumption	W	_	1.35	_	W	_
Starting Voltage	V_{FLS}	_	530	_	Vrms	_
Luminance	L	_	550	_	Cd/m ²	φ , θ =0 deg, I_{FL} =5.0mArms
	X	_	0.340	_	_	_
Chromaticity	y	_	0.370	_	_	_
Luminance Uniformity (Testing 9 point)	_	75%	_	_	%	φ , θ =0 deg, I_{FL} =5.0mArms
Life time	_	17000	_	_	hrs	

CCFL $B\L$ drives directly from A , K.



12. Touch panel Information



ELECTRICAL SPECIFICATIONS

ITEM	SPECIFICATION	CONDITION
ON RESISTANCE	350Ω ~ 1000Ω	DIRECTION:X
	200Ω ~ 650Ω	DIRECTION:Y
INSULATION	MORE THAN	DC 25V
RESISTANCE	$20M\Omega$	
CHATTERING	LESS THAN	100KΩ PULL-UP
TIME	15 msec	
LINEARITY	±1.5%	X AXIS
	±1.5%	Y AXIS

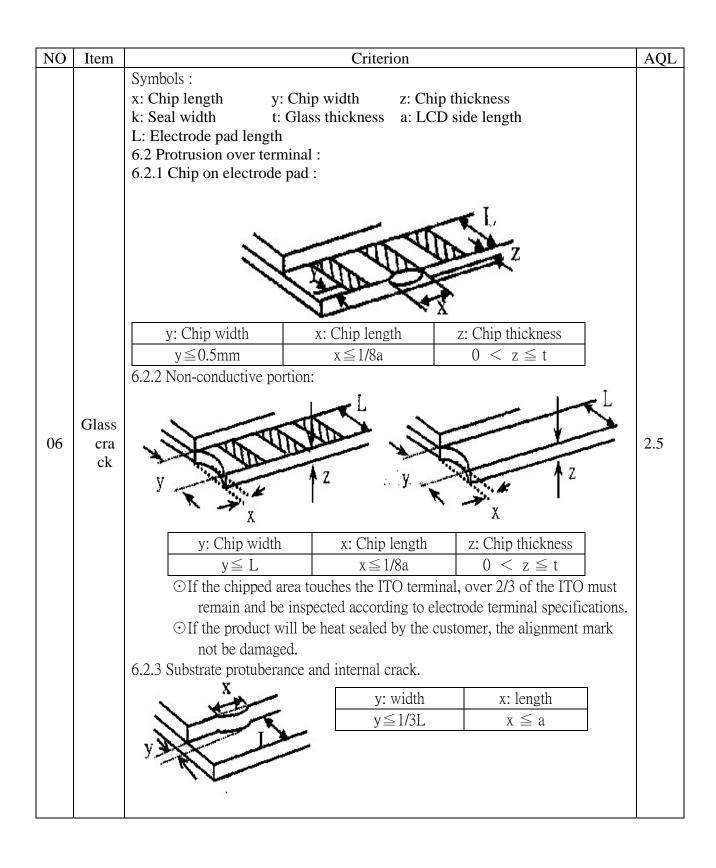
MACHINE SPECIFICATIONS

ITEM	SPECIFICATION	CONDITION
OPERATING	LESS THAN 80g	R8.0 HS 40 °
FORCE		SILICON RUBBER
		OR R0.8
		POLYACETAL PEN
SURFACE	MORE THAN 2H	PENCIL TEST
HARDNESS		
LIGHT	MORE THAN	@550nm
TRANSMISSION	80 %	НІТАСНІ U3300
DURABILITY FOR	ABILITY FOR MORE THAN FORCE:250g	
PEN SELECTIONS	1,200,000 TIMES	SPEED:2cm/sec

13. Inspection specification

NO	Item	Criterion			
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.			
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 			
03	LCD black spots, white spots, contaminati	3.1 Round type : As following drawing $\Phi = (x + y)/2$ $X \qquad \qquad$			
	on (non-display)	3.2 Line type : (As following drawing) Length Width Acceptable Q T $W \le 0.02$ Accept no dense $L \le 3.0 0.02 < W \le 0.03$ $L \le 2.5 0.03 < W \le 0.05$ $0.05 < W$ As round type			
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			

NO	Item	Criterion A			
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination			
		Symbols Define: x: Chip length y: k: Seal width t: L: Electrode pad length 6.1 General glass chip:	k spots, white spots, con Chip width z: Chi Glass thickness a: LC :	ip thickness D side length	
06	Chipped glass	z: Chip thickness $Z \le 1/2t$ $1/2t < z \le 2t$ ① If there are 2 or more $6.1.2 \text{ Corner crack:}$	y: Chip width Not over viewing area Not exceed 1/3k chips, x is total length of	x: Chip length $x \le 1/8a$ $x \le 1/8a$ $x \le 1/8a$ each chip.	2.5
			X	y	
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x≤1/8a	
$1/2t < z \le 2t \qquad \text{Not exceed } 1/2t < z \le 2t$				x≤1/8a	
	⊙ If there are 2 or more chips, x is the total length of each chip.				



NO	Item	Criterion	AQL	
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07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5	
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 		
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.		
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 		
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65	

NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

14. Material List of Components for RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

•

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited	100	1000	1000	1000	1000	1000
Value ppm ppm ppm ppm ppm						
Above limited value is set up according to RoHS.						

2. Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250,30 seconds Max.;

Connector soldering wave or hand soldering: 320, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5 ;

Recommended customer's soldering temp. of connector: 280, 3 seconds.



Module Number:			Page: 1		
1 \ <u>Pa</u>	nel Specification:				
1.	Panel Type:	Pass	□ NG ,		
2.	View Direction:	Pass	□ NG ,		
3.	Numbers of Dots:	Pass	□ NG ,		
4.	View Area:	Pass	□ NG ,		
5.	Active Area:	Pass	□ NG ,		
6.	Operating Temperature:	☐ Pass	□ NG ,		
7.	Storage Temperature:	Pass	□ NG ,		
8.	Others:		-		
2 · <u>M</u>	echanical Specification:				
1.	PCB Size:	Pass	□ NG ,		
2.	Frame Size:	☐ Pass	□ NG ,		
3.	Materal of Frame:	☐ Pass	□ NG ,		
4.	Connector Position:	Pass	□ NG ,		
5.	Fix Hole Position:	☐ Pass	□ NG ,		
6.	Backlight Position:	☐ Pass	□ NG ,		
7.	Thickness of PCB:	☐ Pass	□ NG ,		
8.	Height of Frame to PCB:	Pass	□ NG ,		
9.	Height of Module:	Pass	□ NG ,		
10.	Others:	☐ Pass	□ NG ,		
3 \ <u>R</u> e	elative Hole Size :				
1.	Pitch of Connector:	Pass	□ NG ,		
2.	Hole size of Connector:	Pass	□ NG ,		
3.	Mounting Hole size:	☐ Pass	□ NG ,		
4.	Mounting Hole Type:	Pass	□ NG ,		
5.	Others:	Pass	□ NG ,		
4 · Backlight Specification :					
1.	B/L Type:	Pass	□ NG ,		
2.	B/L Color:	Pass	□ NG ,		
3.	B/L Driving Voltage (Refer	ence for LED	Pass NG,		
4.	B/L Driving Current:	☐ Pass	□ NG ,		
5.	Brightness of B/L:	Pass	□ NG ,		
6.	B/L Solder Method:	☐ Pass	□ NG ,		
7.	Others:	☐ Pass	□ NG ,		

>> Go to page 2 <<



Module Number:			Page: 2		
5 \ <u>F</u>	Electronic Characteristics of N	Module:			
1.	Input Voltage:	Pass	□ NG ,		
2.	Supply Current:	Pass	□ NG ,		
3.	Driving Voltage for LCD:	Pass	□ NG ,		
4.	Contrast for LCD:	Pass	□ NG ,		
5.	B/L Driving Method:	Pass	□ NG ,		
6.	Negative Voltage Output:	Pass	□ NG ,		
7.	Interface Function:	Pass	□ NG ,		
8.	LCD Uniformity:	Pass	□ NG ,		
9.	ESD test:	Pass	□ NG ,		
10.	Others:	Pass	□ NG ,		
6 · <u>\$</u>	Summary :				
	Sales signature:				